



## SPECIFICATION FOR APPROVAL

CUSTOMER:	
CUSTOMER P/N:	
CND-TEK P/N. :	CND-DCM1206M600-2
DESCRIPTION:	Wire Wound Type Common Mode Filter
REF NO:	QTC-002
REV/NO:	A/0
DATE:	2018/06/18
ATTACHMENT:	
SPECIFICATION	

SAMPLE Q'TY OF SAMPLES

PCS

	$\checkmark$	CUSTOMER'S SIGNATURE	REMARK
FULL APPROVED			
CONDITIONAL APPROVED			
REJECTED			



## CND-DCM1206M600-2

## Wire Wound Type Common Mode Filter



V1.0.3 AUG16,2018

## 深圳磁联达电子有限公司

Shenzhen CND-TEK Electronics Co.,Ltd 公司地址: 深圳市南山区西丽镇街道百旺社区牛城村牛城路221号505 TEL: 86-755-29016433 FAX:86-755-27652977 Email: sales2@cd-tek.com Http://www.cd-tek.com



# 变更履历表

变更日期	变更内容	版次	备注
2018-8-16	新制作	A0	

.

.

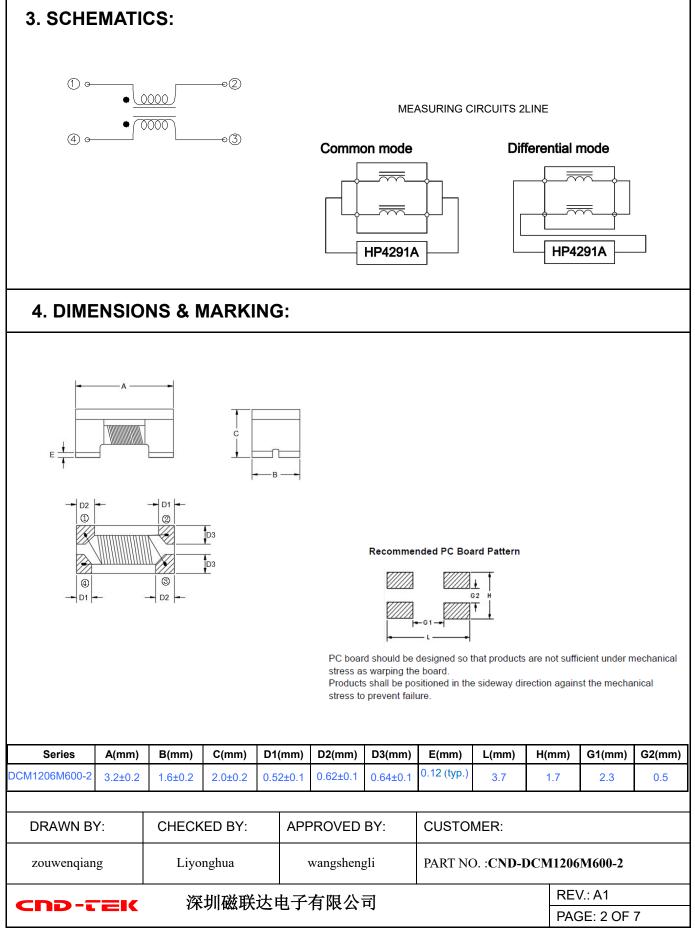
## 1. FEATURES:

- 1.1 High common mode impedance at high frequency effects excellent noise suppression performance.
- 1.2 CND-DCM1206M600-2 Series realizes small size and low profile. 3.2x1.6X2.0 mm.
- 1.3 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 1.4 Operating Temperature range: -40~+125°C (Including self temperature rise)
- 1.5 Storage temperature range:  $-40 \sim +125$  °C (on board)

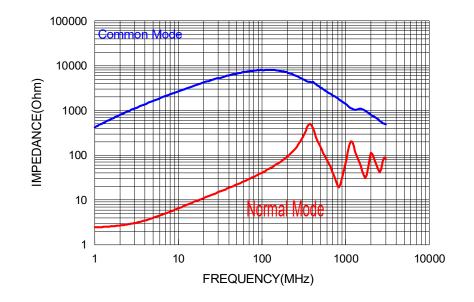
### 2.ELECTRICAL SPECIFICATIONS @25°C

- 2.1 Inductance( µ H) [100kHz/0.1V] Min : 60
- 2.2 Test Frequency (MHz) :100
- 2.3 DCResistance ( $\Omega$ ) max: 1.70
- 2.4 Rated Current (mA)max: 200
- 2.5 Rated Volt.(Vdc)max: 50
- 2.6 Withstand Volt. (Vdc) max:125
- 2.7 IR ( $\Omega$ ) min: 10M

DRAWN BY:	CHECKED BY:	APPROVED BY:	CUSTOMER:	
zouwenqiang	Liyonghua	wangshengli	PART NO. : CND-DCM1206M600-2	
CND-TE		REV.: A0		
	不可加数中	关达电子有限公司		PAGE: 1 OF 7

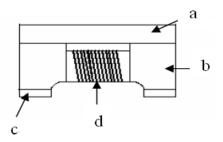


# 5. Typical Impedance v.s. Frequency Curve:



## 6. Materials:

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
с	Termination	Tin (Pb Free)
d	Wire	Enameled Copper Wire



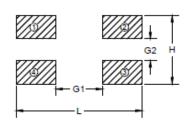
DRAWN BY:	CHECKED BY:	APPROVED BY:	CUSTOMER:		
zouwenqiang	Liyonghua	wangshengli	PART NO. : CND-DCM1206M600-2		
	【 深圳磁联达电-		REV.: A0		
	你则做妖丛电"		PAGE: 3 OF 7		

ltem	Performance			Test Con	dition
Operating temperature	-40~+125 °C (Includir	ng self -			
	temperature rise)				
Storage temperature	-40~+125°C (on board)				
Electrical Performance	Test				
Z(common mode)	Refer to standard	electrical	Agilent-4	291A+ Agilent -16197A	N N
DCR	characteristics list.		Agilent-4	338B	
I.R.			Agilent43	39	
Temperature Rise Test	Rated Current < 1A $\triangle$ T 2	20°CMax	1.Applied	the allowed DC currer	nt.
	Rated Current $\geq$ 1A $\triangle$ T	40°C Max	2.Temper	ature measured by dig	ital surface thermometer
Reliability Test					
Life Test			times.( IF J-STD-02 Temperat Applied of Duration:	tioning: Run through IF PC/JEDEC 20DClassification Reflo cure: 125±2°C urrent: rated current 1000±12hrs d at room temperature	
Load Humidity			Precondi times.( IF J-STD-02 Humidity Temperat Duration	tioning: Run through IF PC/JEDEC 20DClassification Reflo : 85±2 % R.H, ture: 85°C±2°C : 1000hrs Min. with 10	R reflow for 2 w Profiles
Moisture Resistance	Appearance : No damage. Inductance : within±10% of initial value Impedance : within±15% of initial value RDC :within ±15% of initial value and shall not exceed the specification value		times.(IF J-STD-02 1. Baked after plac 2. Raise keep 3 ho 2.5hrs,ke 4. Keep a frequency room tem	ing for 4 hrs. temperature to $65\pm2^{\circ}$ C burs, cool down to $25^{\circ}$ C temperature to $65\pm2^{\circ}$ C burs, cool down to $25^{\circ}$ C ep at 25^{\circ}C for 2 hrs the at 25^{\circ}C 80-100%RH for y of 10 to 55 Hz to 10 h pperature after placing	w Profiles sured at room temperature 90-100%RH in 2.5hrs, and in 2.5hrs. 90-100%RH in 2.5hrs, and in en keep at -10°C for 3 hrs 15min and vibrate at the Hz, measure at for 1~2 hrs.
Thermal shock			times.(IF Reflow P Step1: Step2: 2 Step3: 1 Number of	tioning: Run through IF PC/JEDECJ-STD-020D rofiles Condition for 1 $40\pm2^{\circ}C$ $30\pm5$ min $25\pm2^{\circ}C \leq 0.5$ min $25\pm2^{\circ}C$ $30\pm5$ min of cycles: 500 d at room temperature	Classification
Vibration			Oscillatio Equipme Total Am	n Frequency: 10~2K~ nt: Vibration checker blitude:1.52mm±10% ime : 12 hours(20 minu	~10Hz for 20 minutes
REPORT BY:	CHECKED BY:	APPROVEI	OBY:	CUSTOMER:	
zouwenqiang	Liyonghua	wangsher	ngli	PART NO. : CND-D	CM1206M600-2
					REV.: A
CND-TE	■ 采圳磁联达电				I NEV A

Iten	ו		Performance			Test Condit	ion	
				Туре	Peak	Normal	Wave	Velocity
					value (g ' s)	duration (D) (ms)	form	change (Vi)ft/sec
		Appea	rance: No damage.	SMD	50	11	Half-si	11.3
hock		Inducta	ance: within±10% of				ne	
		initial v	alue	Lead	50	11	Half-si	11.3
			ance : within±15% of		in eesk	diversion of	ne ne	
		initial v		axes.	n each	direction ald	ng s per	pendicula
			within ±15% of initial		mounte	d on a FR4 s	ubstrate	of the
			and shall not	-		ions: >=080	5:40x100	(1.2mm
				<0805:4		).8mm		
Bending		exceed	I the specification value	Bending	-	2mm):1.2mn	•	
					•	2mm):0.8mm		
				duration	•			
				Preheat	,			
		More t	han 95% of the terminal			6 Ag3% Cu0.	5%	
Soderability		electro	de should	Temperature: 245±5°C。				
		be cov	ered with solder。	Flux for lead free: Rosin. 9.5%。 Dip time: 4±1sec。				
				Depth: completely cover the termination			'n	
				Number o		•		
Resistance				Temper	ature	Time(s)		erature
				(°C)				/immersion
o Soldering							and rate	emersion
leat				260 ±5(s	older	10 ±1	25mr	n/s ±6
				temp)			mm/s	
Ferminal Strength		Inducta initial v Impeda initial v RDC : value a	ance:within±15% of	times.(I Reflow F With the device to tested, a inch(201 inch(201 of a devi This forc Also the shall be	PC/JED Profiles compor b be upply a for 2mm):1 2mm):1 2mm):0 (ce being ce shall l force applied upply a sh	Run through EC J-STD-02 ment mounted brce (>0805 kg , <=0805 .5kg)to the s g tested. be applied fo gradually as lock to the co	20DClassi d on a PC ide r 60 +1 se	fication B with the econds. being
REPORT BY:	Y: CHECKED BY:		APPROVED BY:	CUSTO	CUSTOMER:			
zouwenqiang	Liyonghua		wangshengli	PART N	0. : CN	D-DCM120	6M600-2	
		<u>ток у 1 і</u>	ⅎᡔ≁┉╷╴╸			REV.	: A0	
CND-Ti		肝オ大日	电子有限公司					

# 8. Soldering and Mounting:8.1 Recommended PC Board Pattern

<u></u>				
L(mm)	3.70			
H(mm)	1.70			
G1(mm)	2.30			
G2(mm)	0.50			



PC board should be designed so that products can prevent damage from mechanical stress when warping the board. Products shall be positioned in the sideway direction to against the mechanical stress to prevent failure.

### 8.2 Soldering

Mildly activated rosin fluxes are preferred. CND-TEK terminations are suitable for all wave and re-flow soldering systems.

If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-2.1 Lead Free Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2.2 Soldering Iron(Figure 2):

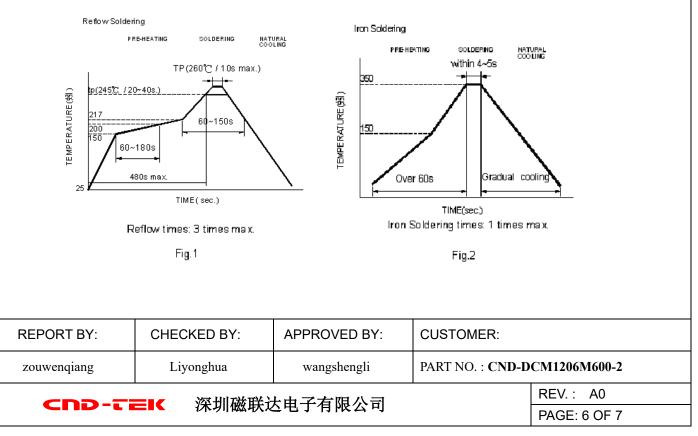
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that

a soldering iron must be employed the following precautions are recommended.

Preheat circuit and products to  $150^{\circ}$ C ·Never contact the ceramic with the iron tip ·Use a 20 watt soldering iron

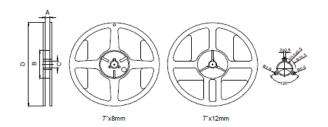
with tip diameter of 1.0mm

355 tip temperature (max) 1.0mm tip diameter (max) Limit soldering time to 4~5 sec.



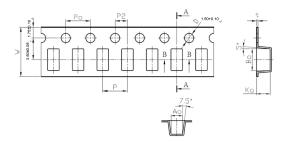
## 9、Packaging Information:

### 9.1 Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2

### 9.2 Tape Dimension / 8mm



Serie	es	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	W(mm)	t(mm)
CND-DCM1206	M600-2	4.00±0.10	4.00±0.10	2.00±0.05	3.50±0.10	1.88±0.10	2.20±0.10	8.00±0.10	0.26±0.05

### 9.3 Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
CND-DCM1206M600-2	2000	10000	50000	100000

### 9.4 Tearing Off Force

Top cover tape

Base tape

165 to180

The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

#### Application .....

Storage Conditions (component level)

- To maintain the solderability of terminal electrodes:
- 1. CND-TEK products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40  $^\circ\!{\rm C}$  and 60% RH.
- 3. Remmended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.

- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- $\ensuremath{\mathsf{3.Bulk}}$  handling should ensure that abrasion and mechanical shock are minimized.

REPORT BY:	CHECKED BY:	APPROVED BY:	CUSTOMER:	
zouwenqiang	Liyonghua	wangshengli	PART NO. : CND-DCM1206M600-2	
CND-Ti	■■■ 深圳磁联边		REV.: A0	
	小川做妖人		PAGE: 7 OF 7	

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Common Mode Chokes / Filters category:

Click to view products by CND-tek manufacturer:

Other Similar products are found below :

PE-64683 RD5122-6-9M6 ST6118T-R FE3X025-10-7NL T8114NLT TCM0806G-350-2P-T TCM0806G-650-2P-T IND-0110 UAL21VR0802000 UALSC02300000 UALSC1020JH000 UALSU10VD20010 UALSU9VD070100 36-00037 CM7060M132R-10 UALW21HS072450 UALSU9H0208000 UAL24VK06450CH PLT10HH501100PNB PLT10HH401100PNB PLT10HH1026R0PNB 36-00029-01 PE-67531 TLH10UB 113 0R5 2752045447 CM8663Z161B-10 7351V CMF16-153131 T8116NLT CMS2-10-R FE2X10-4-2NL T8003NLT CTX01-13663 CTX66-19521-R RC212-0.5-10M RC112-0.4-15M RC212-0.6-6M8 RC212-0.4-15M RC112-0.3-30M 4534-3 WTCF2012Z0M751PB PH9408.814NLT B82498B3221J000 PAC6006.364NLT PAC6006.444NLT PAC6006.204NLT PH9407.204NLT PAC6006.264NLT PH9408.105NLT PH9408.494NLT